



Dual-Cure 9483

High-Performance Light + Moisture-Cure Conformal Coating

APPLICATIONS

- Conformal Coatings
- Automotive Sensors
- Control Modules

FEATURES

- UV/Visible Light Cure
- Secondary Moisture Cure
- Excellent Thermal Shock Resistance
- Corrosion Resistant
- Temperature/Humidity Performance

OTHER FEATURES

- Bright Blue Fluorescing
- UL 94V-0 Flammability
- UL 746-E
- MIL-I-46058C Listed
- Meets IPC-CC-830B

Dymax dual-cure 9483 is a high-performance light and moisture-cure reworkable conformal coating especially formulated to ensure complete cure for coating that flows underneath components on printed circuit boards. Coating in shadow areas cures over time with ambient moisture. Dymax 9483 is engineered for coating thicknesses up to 0.203 mm (0.008 in). This conformal coating fluoresces a vivid blue when exposed to UV light (365 nm) for easy inspection of coating coverage. Dymax dual-cure materials contain no nonreactive solvents. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing focused-beam lamps or flood lamps, they deliver optimum speed and performance for electronic assembly. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

UNCURED PROPERTIES *

Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Acrylated Urethane	N/A
Appearance	Clear, Light Yellow Liquid	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.09	ASTM D1875
Viscosity, cP (20 rpm)	750 (nominal)	DSTM 502†
Shelf Life @RT (22°C to 25°C) from Date of Manufacture	7 months	N/A

CURED MECHANICAL PROPERTIES *

Property	Value	Test Method
Durometer Hardness (UV Only)	A55	ASTM D2240
Durometer Hardness	D60	ASTM D2240
Tensile at Break, MPa [psi]	16.2 [2,350]	ASTM D638
Elongation at Break, %	22	ASTM D638
Modulus of Elasticity, Mpa [psi]	276 [40,000]	ASTM D638

ELECTRICAL PROPERTIES *

Property	Value	Test Method
Dielectric Constant (1 MHz)	3.26	ASTM D150
Dissipation Factor (1 MHz)	0.2	ASTM D150
Volume Resistivity, ohm-cm	4.39E+14	ASTM D257
Surface Resistivity, ohm	2.22E+12	ASTM D257
Dielectric Withstand Voltage, kV/mm [V/mil]	59 [1500]	ASTM D149

OTHER CURED PROPERTIES *

Property	Value	Test Method
Refractive Index (20°C)	1.51	ASTM D542
Boiling Water Absorption, % (2 h)	1.4	ASTM D570
Water Absorption, % (25°C, 24 h)	0.3	ASTM D570
Linear Shrinkage, %	2.0	ASTM D2566
Glass Transition Tg, °C	57	ASTM D5418
CTE α_1 , $\mu\text{m}/\text{m}/^\circ\text{C}$	87	ASTM E831
CTE α_2 , $\mu\text{m}/\text{m}/^\circ\text{C}$	188	ASTM E831
Flammability	V0	UL 94
Thermal Shock, -65°C to 125°C	50 cycles	MIL-I-46058C
Moisture Resistance	Passes	MIL-I-46058C
Fungus Resistance (ASTM G21-13)	Passes	MIL-I-46058C

ADHESION

Substrate	Recommendation
Lead Frame	✓
Ceramic	✓
PCB	✓
Flex	✓

✓ Recommended o Limited Applications
st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)

* Not Specifications

N/A Not Applicable

† DSTM Refers to Dymax Standard Test Method

‡ Measured after UV cure followed by 15 days at 25°C/50% RH

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CURING GUIDELINES

UV-curing guidelines for 9483 at 0.008 in (0.20 mm)

Dymax Curing System (Intensity)	Fixture Time or Belt Speed
5000-EC (225 mW/cm ²) ^A	50 s
UVCS Conveyor with Fusion D lamp (2.5 W/cm ²) ^B	1.5 m/min [5 ft/min]
UVCS Conveyor with one 5000-EC (250 mW/cm ²) ^B	0.3 m/min [1 ft/min]

^A Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

^B Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 160 Radiometer.

SECONDARY MOISTURE CURE

A combination of light and moisture cure is required to achieve full cured mechanical properties. Moisture is also used as a secondary cure mechanism for shadow areas that cannot be cured with light. While moisture cure time in shadow areas is typically 2-3 days at 25°C [77°F], 50% RH, actual moisture cure time is application specific and may vary.

For material that has been light cured, typical full property development is after 7 days at 25°C [77°F], 50% RH or 2 days at 40°C, 50% RH.

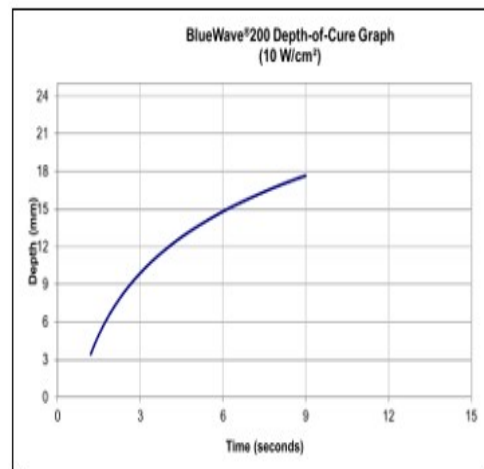
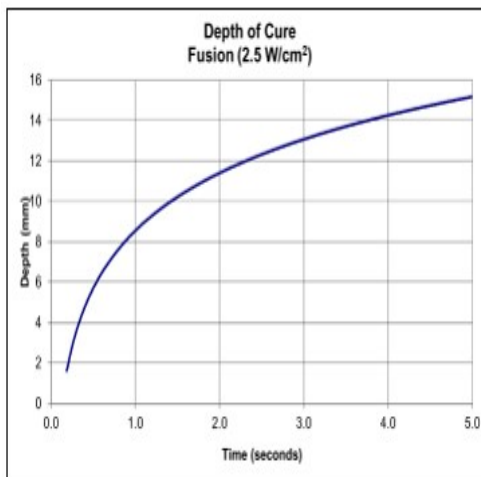
Cure time for both light-cured and shadow areas depends on humidity level, amount of material in shadow areas, and its proximity to humidity. Material entrapped under large components may have a prolonged cure time. Exposure to heat (typically 40°C-60°C) and higher relative humidity will accelerate cure.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light exposure no longer improves cured properties.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer must ultimately determine and qualify the appropriate curing parameters required for their unique application.

DEPTH OF CURE

The graph below shows the increase in depth of cure as a function of exposure time. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.





OPTIMIZING PERFORMANCE AND HANDLING

1. This product cures with exposure to UV and visible light as well as moisture. Exposure to ambient and artificial light and moisture should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.
3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.
9. Resealing opened container under a dry, inert gas, such as nitrogen, can help to prolong the shelf life.
10. Light cure is recommended prior to moisture cure. Full cure develops after both light and moisture cure, not one or the other.

DISPENSING THE RESIN

Dymax conformal coatings are typically applied via spraying. Dymax offers several dispensing systems that may be suitable for manual, semi-automated, and fully automated fluid-delivery of the conformal coatings including our Model 110 mountable atomizing valve, the eco-PEN450 valve, or the SG-150-RS handheld spray gun. Non-atomized, small-area, or manual touch-up applications can be achieved with options like our SD-100 syringe dispenser or the Model 400 needle valve.

Questions relating to and defining the best fluid-delivery system and curing equipment for specific applications should be discussed with the Dymax Application Engineering Team.

STORAGE AND SHELF LIFE

Store the material in a low humidity, cool, and dark place when not in use. This product may polymerize upon prolonged exposure to ambient and artificial light as well as moisture. This material shelf life noted on page 1 of this document, when stored between 10°C (50°F) and 32°C (90°F) in the original, unopened container.

Resealing large containers under dry inert gas, such as nitrogen, can help maintain the shelf life. Smaller syringes and cartridges should be kept in moisture barrier bags with desiccant when not in use.

CLEAN UP

Uncured Dymax dual-cure materials may be removed from dispensing components and parts with non-alcoholic solvents. Alcoholic solvents (such as IPA or ethanol) that contain moisture activate the curing process. Therefore, it is recommended that non-alcohols such as Butyl Acetate Acetone or MEK be used to cleanup uncured material and purge wetted dispensing lines.

Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife and/or warming to aid in the removal.



ELECTRONIC CIRCUIT BOARD MATERIALS

9483 Product Data Sheet

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

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